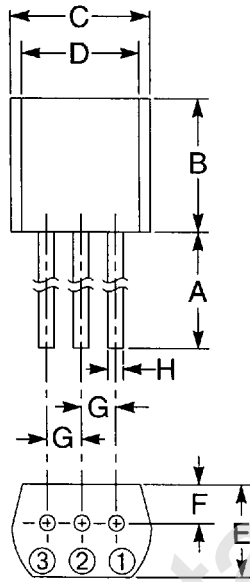


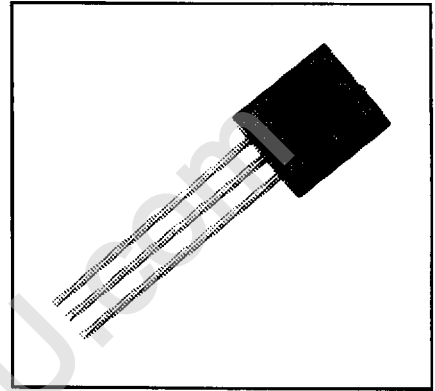
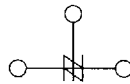
### Silicon Bilateral Switch

#### OUTLINE DRAWING



#### CONNECTION DIAGRAM

- ① TERMINAL 1
- ② GATE
- ③ TERMINAL 2



#### Description:

The BS08A bilateral switch is a silicon planar monolithic integrated circuit with the electrical characteristics of a bilateral thyristor. The device is designed to switch at 7 to 9 volts with a 0.01%/°C temperature coefficient and have excellently matched characteristics in both directions.

#### Features:

- Low Switching Voltage of 7 to 9 Volts
- Excellent Switching Voltage Temperature Characteristics (0.01%/°C)
- High Reliability Devices
- Gate Electrode Facilitating Switching Operation Control and Synchronization.

#### Applications:

- Trigger Circuits for Thyristor or Triac, Oscillators, Timers

#### Ordering Information:

Example: Select the complete five digit part number you desire from the table - i.e. BS08A is a 175mA Silicon Bilateral Switch.

Type
BS08A

#### Outline Drawing

Dimensions	Inches	Millimeters
A	0.492 Min.	12.5 Min.
B	0.13 Max.	3.3 Max.
C	0.17	4.3
D	0.14	3.55
E	0.098 Max.	2.5 Max.
F	0.035	0.9
G	0.049 ± 0.012	1.25
H	0.018	0.45



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**BS08A**  
Silicon Bilateral Switch

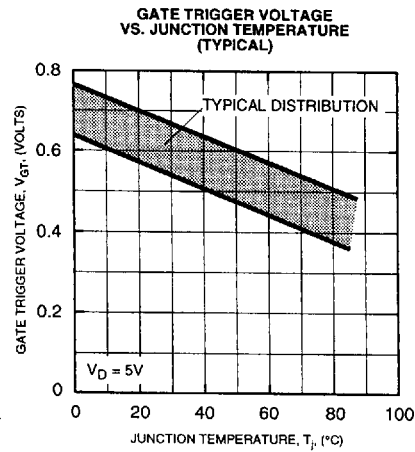
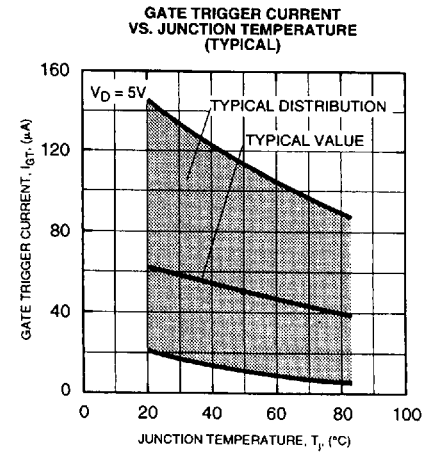
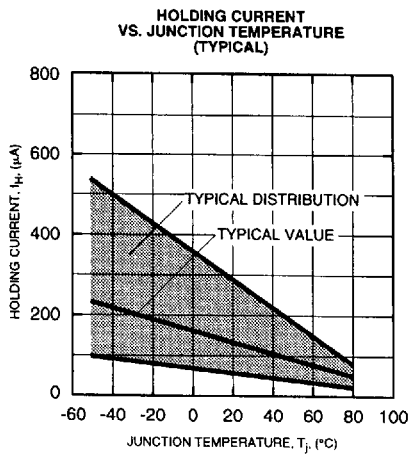
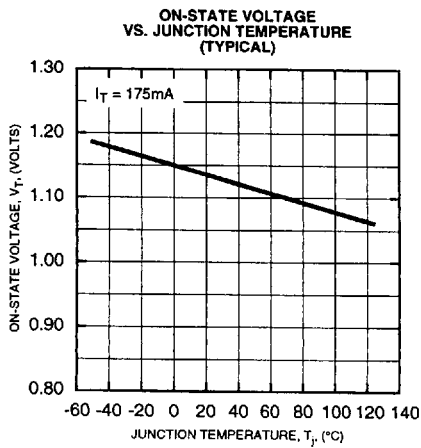
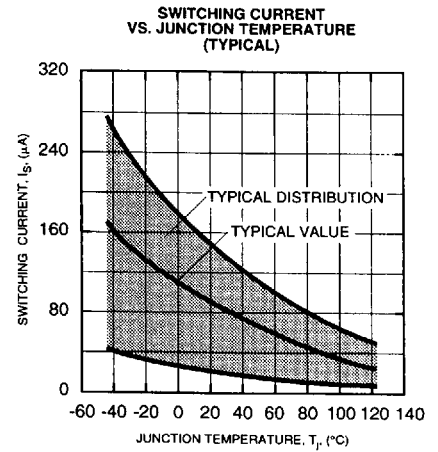
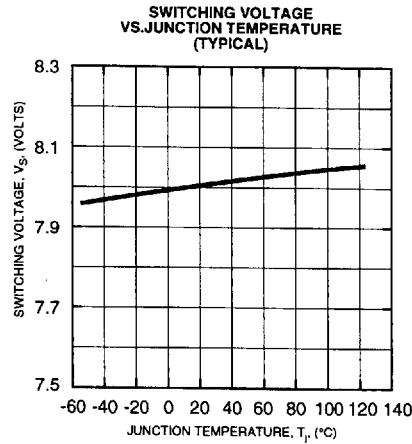
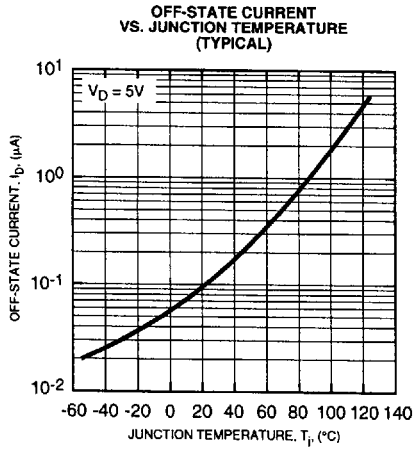
**Absolute Maximum Ratings,  $T_a = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Ratings	Symbol	BS08A	Units
DC Forward Anode Current	$I_T$	175	mA
Repetitive Peak Forward Current (1% Duty Cycle, 10 $\mu$ s Pulsewidth), $T_a = 100\text{ }^\circ\text{C}$	–	1.0	Amperes
Non-repetitive Peak Forward Current (10 $\mu$ s Pulsewidth)	–	2.0	Amperes
Power Dissipation	$P_T$	250	mW
DC Gate Current	$I_G$	5	mA
Storage Temperature	$T_{stg}$	-55 to 125	$^\circ\text{C}$
Operating Temperature	$T_j$	-55 to 125	$^\circ\text{C}$

**Electrical and Thermal Characteristics,  $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	BS08A			Units
			Min.	Typ.	Max.	
Switching Voltage	$V_S$	$T_a = 25\text{ }^\circ\text{C}$	7	8	9	Volts
Switching Current	$I_S$	$T_a = 25\text{ }^\circ\text{C}$	–	–	200	$\mu\text{A}$
Absolute Switching Voltage Difference	$ V_{S1} - V_{S2} $	$T_a = 25\text{ }^\circ\text{C}$	–	–	0.5	Volts
Absolute Switching Current Difference	$ I_{S1} - I_{S2} $	$T_a = 25\text{ }^\circ\text{C}$	–	–	100	$\mu\text{A}$
Holding Current	$I_H$	$T_a = 25\text{ }^\circ\text{C}$	–	–	1.5	mA
Off-state Current	$I_D$	$V_D = 5\text{V}, T_a = 25\text{ }^\circ\text{C}$	–	–	1.0	$\mu\text{A}$
		$V_D = 5\text{V}, T_a = 85\text{ }^\circ\text{C}$	–	–	10	$\mu\text{A}$
Temperature Coefficient of Switching Voltage	–	$T_a = -55\text{ to }85\text{ }^\circ\text{C}$	–	$\pm 0.01$	–	$\%/^\circ\text{C}$
Peak On-state Voltage	$V_T$	$I_T = 175\text{mA}, T_a = 25\text{ }^\circ\text{C}$	–	–	1.4	Volts
Gate Trigger Current	$I_{GT}$	$V_D = 5\text{V}, T_a = 25\text{ }^\circ\text{C}$	10	–	200	$\mu\text{A}$
Gate Non-trigger Voltage	$V_{GD}$	$V_D = 5\text{V}, T_a = 85\text{ }^\circ\text{C}$	0.2	–	–	Volts

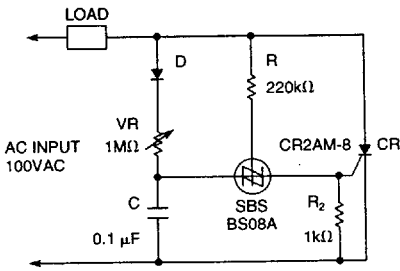
**BS08A**  
Silicon Bilateral Switch



**BS08A**  
Silicon Bilateral Switch

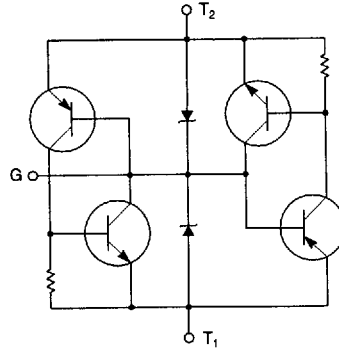
**APPLICATION EXAMPLES**

**THYRISTOR TRIGGER CIRCUIT**

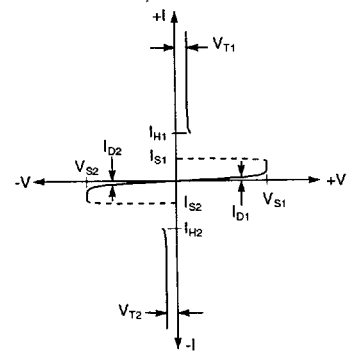


This circuit is widely used in DC motor control and other control applications.

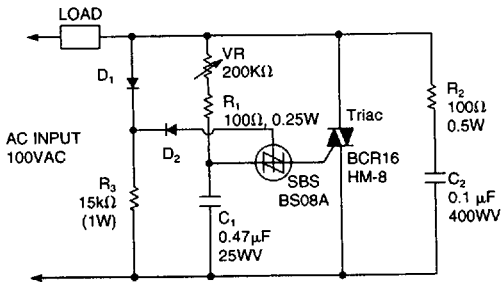
**EQUIVALENT CIRCUIT**



**STATIC CHARACTERISTICS**

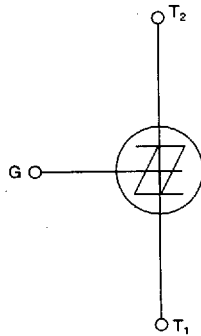


**TRIAC TRIGGER CIRCUIT**

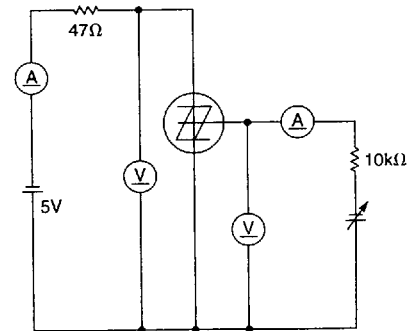


This circuit is useable in such applications as lighting control circuits, electric heater control, and other load control applications.

**CIRCUIT SYMBOL**



**GATE CHARACTERISTICS MEASUREMENT CIRCUIT**





T-91-01

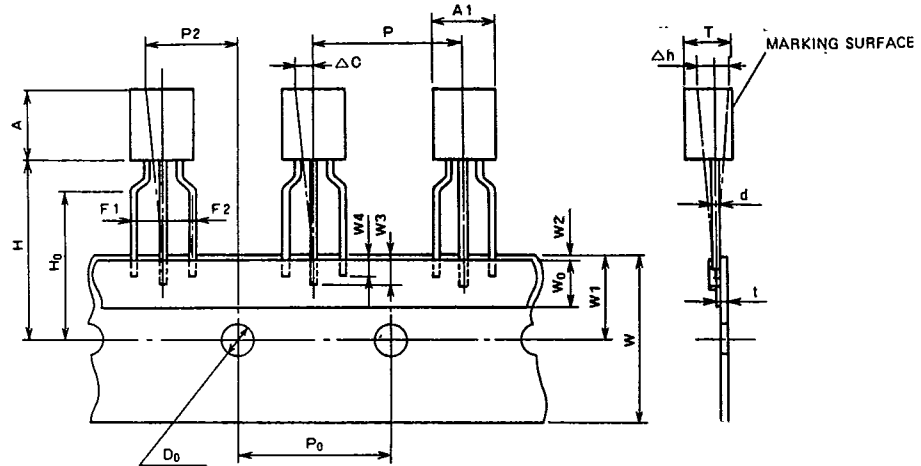
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 Powerex Europe, S.A., 428 Avenue G. Durand, BP107, 72003 Le Mans, France (43) 41.14.14

## Taping

### STANDARD SPECIFICATIONS FOR TAPING OF MOLDED PACKAGE THYRISTORS AND TRIACS

#### TO-92 Package

Thyristor  
CR02AM, CR03AM, CR04AM  
Triac  
BCR1AM



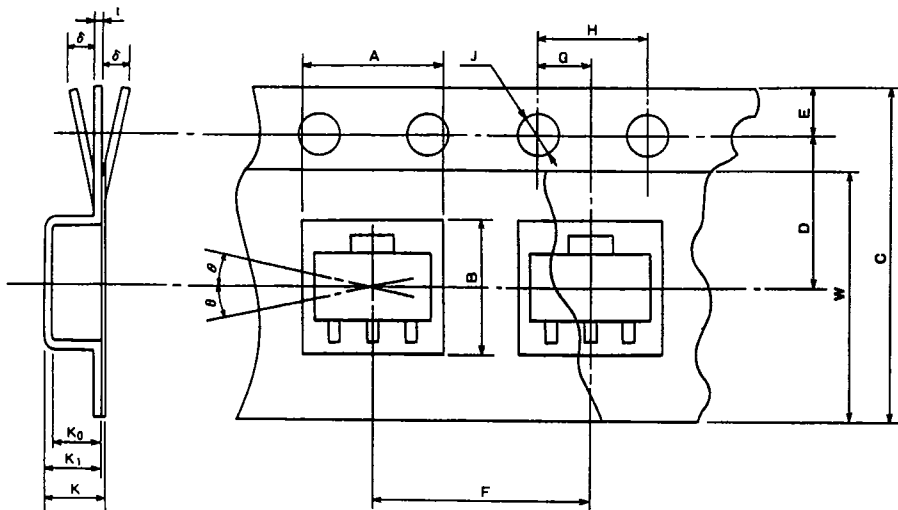
Taping dimensions

Description of symbol	Symbol	Dimensions (Unit:mm)	Remark
Product width	A1	5.0 MAX	
Product height	A	5.0 MAX	
Product thickness	T	3.7 MAX	
Lead wire diameter	d	0.6 MAX	
Sticker lead wire length (1)	W3	2.5 MIN	
Sticker lead wire length (2)	W4	2.0 MIN	
Pitch between products	P	12.7 ± 1.0	
Feed hole pitch	P <sub>0</sub>	12.7 ± 0.3	The cumulative pitch error is ± 1mm per 20 pitches.
Feed hole deviation (1)	P2	6.35 ± 1.3	
Distance between lead wires	F1, F2	2.5 ± 0.4	
Defective product (1)	Δh	0 ± 2.0	
Tape width	W	18.0 ± $\begin{smallmatrix} 1.0 \\ 0.5 \end{smallmatrix}$	
Sticker tape width	W <sub>0</sub>	6.0 ± 0.5	
Feed hole deviation (2)	W1	9.0 ± 0.5	
Sticker tape deviation	W2	0.5 MAX	
Position of product bottom surface	H	17.5 MIN	
Lynch height of lead wire	H <sub>0</sub>	16.0 ± 0.5	
Feed hole diameter	D <sub>0</sub>	4.0 ± 0.2	
Tape thickness	t	0.7 ± 0.2	
Defective product (2)	ΔC	0 ± 1.0	



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Powerex Semiconductor Data Book  
 Taping



SOT-89 Package

Thyristor  
 CR08AS

Taping dimensions

Description of symbol		Symbol	Dimensions/angles Unit:mm	Remark
Parts Insertion	Height	A	$5.0 \pm 0.1$	Cross-section of the surface 0.5mm above the inner bottom
	Width	B	$4.6 \pm 0.1$	Cross-section of the surface 0.5mm above the inner bottom
Concave square hole	Depth	$K_0$	$1.8 \pm 0.1$	Inner space
	Pitch	F	$8.0 \pm 0.1$	Cumulative error +0.1/-0.3 MAX/10 pitches
Round feed hole	Diameter	J	$\phi 1.5 \pm 0.05$	
	Pitch	H	$4.0 \pm 0.1$	Cumulative error +0.1/-0.3 MAX/10 pitches
	Position	E	$1.5 \pm 0.1$	Distance between the tape edge and the hole center
Distance between center lines	Vertical	G	$2.0 \pm 0.5$	Center line of concave square hole and round feed hole
	Horizontal	D	$5.65 \pm 0.05$	Center line of concave square hole and round feed hole
Cover tape	Width	W	$9.5 + 0.3/-0$	Thickness: 0.1 MAX
Carrier tape	Width	C	$12 \pm 0.2$	Warp $\pm 0.3$ MAX
	Thickness	t	$0.3 \pm 0.05$	
	Package hole depth	$K_1$	$2.1 \pm 0.1$	
Device	Package dimensions	—	—	As shown in (e)
	Inclination	$\theta$	30° MAX.	
Total Thickness		K	$2.3 \pm 0.1$	Total thickness including cover and carrier tapes